

# TS-XFP-DWDM-40

## 10Gbps DWDM XFP Optical Transceiver, 40km Reach

### **Features**

- Supports 9.95Gb/s to 11.1Gb/s bit Rates
- · Hot-pluggable XFP Footprint
- Temperature-Stabilized DWDM Rated EML Transmitter
- · 100GHz ITU Grid, C Band
- Duplex LC Connector
- Power Dissipation <3.5W
- Built-in Digital Diagnostic Functions
- · Support Line Side Loopback
- Support XFI Loopback
- · Auxiliary 1 Monitoring Laser Temperature
- · Auxiliary 2 Monitoring 5V Supply
- Operating Case Temperature Standard: 0°C to +70°C

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## **Applications**

- SONET OC-192 & SDH STM 64
- 10GBASE ER/EW
- DWDM Networks
- ITU-T G.709

## Description

TONGSION DWDM XFP Transceiver exhibits excellent wavelength stability, supporting operation at 100 GHz channel, cost effective module. It is designed for 10G DWDM SDH, 10GBASE-ER/EW and 10G Fiber Channel applications.

The transceiver consists of two sections: The transmitter section incorporates a colded EML laser. And the receiver section consists of a PIN photodiode integrated with a TIA. All modules satisfy class I laser safety requirements. TONGSION DWDM XFP transceiver provides an enhanced monitoring interface, which allows real-time access to device operating parameters such as transceiver temperature, laser bias current, transmitted optical power, received optical power and transceiver supply voltage.





Absolute Maximum Ratings\*Note

Parameter	Symbol	Min	Max	Unit
Maximum Supply Voltage	Vcc	-0.5	4.0	V
Operating Relative Humidity RH			80	%
Storage Temperature Ts		-40	+85	°C

Note: Exceeding any one of these values may destroy the device permanently.

# **Recommended Operating Conditions**

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Tc	0		+70	°C
Pow er Supply Voltage @ 3.3V	Vcc3	3.13	3.3	3.45	V
Pow er Supply Voltage @ 5V	Vcc5	4.75	5	5.25	V
Supply Current-Vcc3 supply	lcc3			300	mA
Supply Current-Vcc5 supply	lcc5			750	mA

## **Electrical Characteristics**

Parameter	Symbol	Min	Typical	Max	Unit	Notes	
Transmitter							
Input Differential Impedance	Rin		100		Ω	1	
Differential Data Input Swing	Vin,pp	120		820	mV		
Transmit Disable Voltage	V <sub>D</sub>	2.0		Vcc	V		
Transmit Enable Voltage	V <sub>EN</sub>	GND		GND+ 0.8	V		
Transmit Disable Assert Time				10	us		
		Receive					
Differential Data Output Swing	Vout,pp	340	650	850	mV	1	
Rise Time (20-80%)	tr			38	ps		
Fall Time (20- 80%)	tf			38	ps		
LOS Fault	V <sub>LOS fault</sub>	Vcc -0.5		VccHOST	V	2	
LOS Normal	V <sub>LOS norm</sub>	GND		GND+0.5	V	2	

Note1: After internal AC coupling

Note2: Loss of signal is open collector. Logic 0 indicates normal operation; logic 1 indicates no signal detected.



# **Optical Characteristics**

Parameter	Symbol	Min	Typical	Max	Unit	Note	
Transmitter							
Centre Wavelength			100		GHz		
Centre wavelength			0.8		nm		
Optical Wavelength-EOL	λς	X-100	Х	X+100	pm		
Transmitter Center Wavelength -BOL	λς	X-40	Х	X+40	pm		
Spectral Width (-20dB)	Δλ			0.3	nm		
Side Mode Suppression Ratio	SMSR	30			dB		
Average Output Power	Pout	-1		4	dBm		
Extinction Ratio	ER	8.2			dB		
Transmitter and Dispersion Penalty	TDP			2	dB		
TX Jitter Generation (peak-to-peak)	TXj			0.1	UI		
TX Jitter Generation (RMS)	TXj <sub>RMS</sub>			0.01	UI		
	Receive	r					
Centre Wavelength	λς	1270		1600	nm		
Receiver Sensitivity	P <sub>min</sub>			-16.5	dBm		
Receiver Overload	P <sub>MAX</sub>	0.5			dBm		
Receiver Reflectance	Rf			-27	dB		
LOS De-Assert	LOS <sub>D</sub>			-18	dBm		
LOS Assert	LOSA	-29			dBm		
LOS Hysteresis		1			dB		

# **DWDM Wavelength Guide**

Table 1- DWDM Wavelength Guide

ITU Channel Product Code	Frequency (THz)	Wavelength (nm)	ITU Channel Product Code	Frequency (THz)	Wavelength (nm)
17	191.7	1563.86	40	194.0	1545.32
18	191.8	1563.05	41	194.1	1544.53
19	191.9	1562.23	42	194.2	1543.73
20	192.0	1561.42	43	194.3	1542.94
21	192.1	1560.61	44	194.4	1542.14
22	192.2	1559.79	45	194.5	1541.35
23	192.3	1558.98	46	194.6	1540.56
24	192.4	1558.17	47	194.7	1539.77
25	192.5	1557.36	48	194.8	1538.98
26	192.6	1556.55	49	194.9	1538.19



# **SFP Series**

27	192.7	1555.75	50	195.0	1537.40
28	192.8	1554.94	51	195.1	1536.61
29	192.9	1554.13	52	195.2	1535.82
30	193.0	1553.33	53	195.3	1535.04
31	193.1	1552.52	54	195.4	1534.25
32	193.2	1551.72	55	195.5	1533.47
33	193.3	1550.92	56	195.6	1532.68
34	193.4	1550.12	57	195.7	1531.90
35	193.5	1549.32	58	195.8	1531.12
36	193.6	1548.51	59	195.9	1530.33
37	193.7	1547.72	60	196.0	1529.55
38	193.8	1546.92	61	196.1	1528.77
39	193.9	1546.12			

Note: Please contact with TONGSION for the channel availability.

# **Pin Descriptions**

Pin	Logic	Symbol	Name/Description	Note
1		GND	Module Ground	1
2		VEE5	Optional -5.2V Pow er Supply (Not required)	
3	LVTTL-I	MOD_DESEL	Module De-select; When held low allows the module to respond to 2-wire serial interface	
4	LVTTL-O	INTb	Interrupt; Indicates presence of an important condition which can be read via the 2-wire serial interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Turns off transmitter laser output	
6		VCC5	+5V Pow er Supply	
7		GND	Module Ground	1
8		VCC3	+3.3V Pow er Supply	
9		VCC3	+3.3V Pow er Supply	
10	LVTTL-I/O	SCL	2-Wire Serial Interface Clock	2
11	LVTTL-I/O	SDA	2-Wire Serial Interface Data Line	2
12	LVTTL-O	MOD_Abs	Indicates Module is not present. Grounded in the Module	2
13	LVTTL-O	MOD_NR	Module Not Ready; Indicating Module Operational Fault	2
14	LVTTL-O	RX_LOS	Receiver Loss Of Signal Indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RDN	Receiver Inverted Data Output	
18	CML-O	RDP	Receiver Non-Inverted Data Output	
19		GND	Module Ground	1



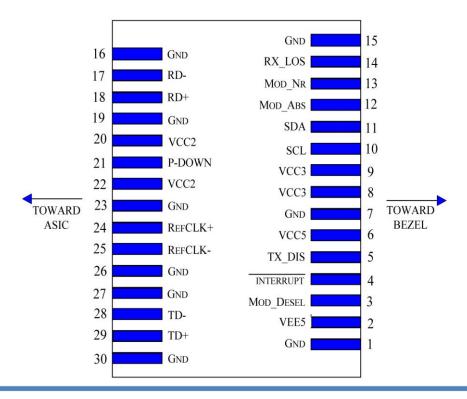
# **SFP Series**

20		VCC2	+1.8V Pow er Supply (Not required).	3
21	LVTTL-I	P_DOWN/RST	Pow er down; When high, requires the module to limit pow er consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode.	
			Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Pow er Supply (Not required)	3
23		GND	Module Ground	1
24	PECL-I	REFCLKP	Not used, internally terminated to 50ohm (100ohm diff).	4
25	PECL-I	REFCLKN	Not used, internally terminated to 50ohm (100ohm diff).	4
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TDN	Transmitter Inverted Data Input	
29	CML-I	TDP	Transmitter Non-Inverted Data Input	
30		GND	Module Ground	1

#### Notes:

- 1. Module ground pins GND are isolated from the module case and chassis ground within the module.
- $2. \ Open \ collector; \ shall \ be \ pulled \ up \ with \ 4.7 K-10 Kohmsto \ a \ voltage \ between \ 3.15 V \ and \ 3.6 V \ on \ the \ host \ board.$
- 3. The pinsare open within module.
- 4. Reference Clockis not required.

## Host board Connector Pin out



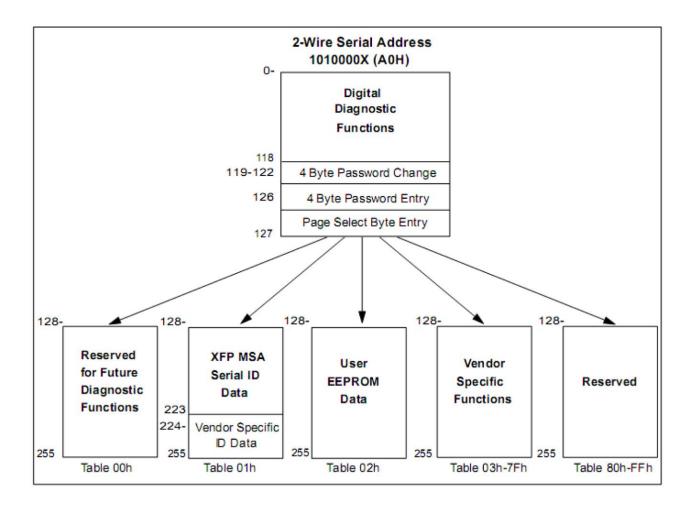


# Management Interface

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

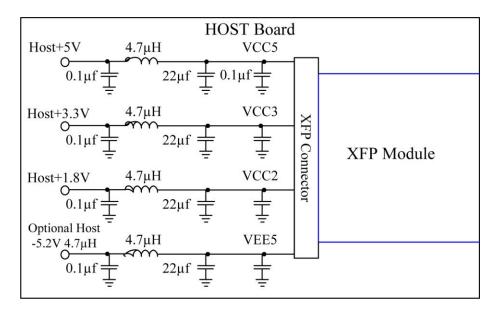
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented.

The digital diagnostic memory map specific data field defines as following.

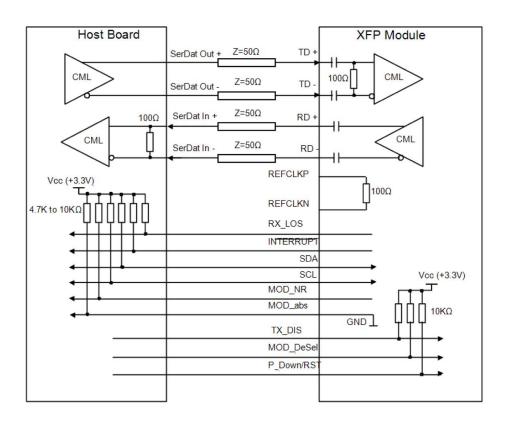




# Recommended Host Board Power Supply Circuit

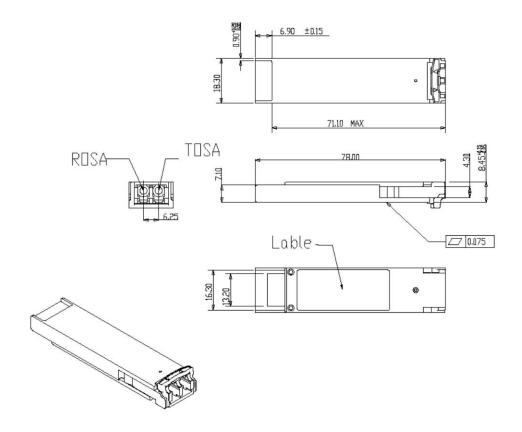


## Recommended High-speed Interface Circuit





# Package Dimensions



## **Eye Safety**

This single-mode transceiver is a Class 1 laser product. It complies with IEC-60825 and FDA 21 CFR 1040.10 and 1040.11. The transceiver must be operated within the specified temperature and voltage limits. The optical ports of the module shall be terminated with an optical connector or with a dust plug.



# Regulatory Compliance

Feature	Stand ard	Perform ance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883G Method 3015.7	Class 1C (>1000 V)
Electrostatic Discharge to the enclosure	EN 55024:1998+A1+A2 IEC-61000-4-2 GR-1089-CORE	Compliant with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN55022:2006 CISPR 22B:2006 VCCI Class B	Compliant with standards Noise frequency range: 30 MHz to 6 GHz. Good system EMI design practice required to achieve Class B margins. System margins depend on customer host board and chassis design.
Immunity	EN 55024:1998+A1+A2 IEC 61000-4-3	Compliant with standards. 1kHz sine-wave, 80% AM, from 80 MHz to 1 GHz. No effection transmitter/receiver performance is detectable between these limits.
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1:2007 EN (IEC) 60825-2:2004+A1	CDRH compliant and Class I laser product.  TüV Certificate No. 50135086
Component Recognition	UL and CUL EN60950-1:2006	UL file E317337 TüV Certificate No. 50135086 (CB scheme )
RoHS6	2002/95/EC 4.1&4.2 2005/747/EC 5&7&13	Compliant with standards *note

## Note:

For update of the equipments and strict control of raw materials, TONGSION has the ability to supply the customized products since Jan 1st, 2007, which meets the requirements of RoHS6 (Restrictions on use of certain Hazardous Substances) of European Union.

In light of item 5 in RoHS exemption list of RoHS Directive 2002/95/EC, Item 5: Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.

In light of item 13 in RoHS exemption list of RoHS Directive 2005/747/EC, Item 13: Lead and cadmium in optical and filter glass. The three exemptions are being concerned for TONGSION's transceivers, because TONGSION's transceivers use glass, which may contain Pb, for components such as lenses, isolators, and other electronic components.



# Ordering information

Part Number	Product Description
TS-XFP-DWDM-40	DWDM, 10Gbps, LC, 40km, 0°C~+70°C, With DDM

Note: XX refers to DWDM Wavelength channel as ITU-T specified, please refer the Table 1-DWDM Wavelength Guide for detailed center wavelength information.

# Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by TONGSION before they become applicable to any particular order or contract. In accordance with the TONGSION policy of continuous improvement specifications may change without notice.

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